西北臺慶科技股份有限公司
TAI-TECH Advanced Electronics Co.,Ltd.

OTC Code TAI-TECH 3357

TAI-TECH Advanced Electronics Co., Ltd.

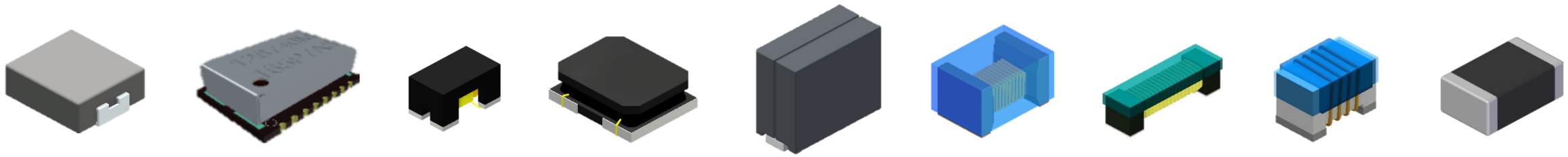
Investor Conference of OTC Market

Q3, 2026

Investor Contact Window:

TEL: (03) 4641148 Ext.1203 (Ms. Chang)

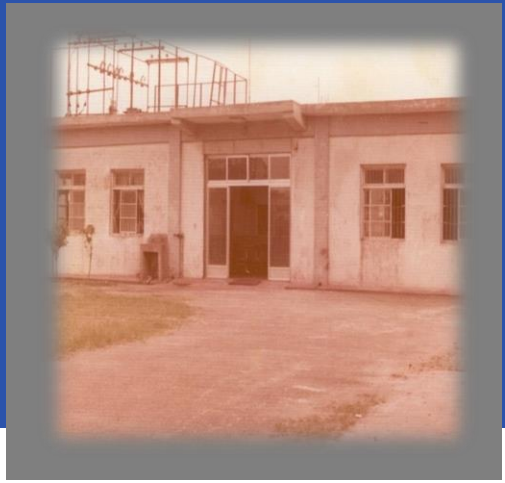
E-Mail: invest@tai-tech.com.tw



Disclaimer

- This file and the financial information and forecast information are based on information obtained by the company from internal and external sources. The actual operating results and financial conditions of the company may differ from these predictive sets of information due to various uncontrollable factors.
- The viewpoints in this file reflects the company's opinion on the future by the current date. If there are any changes or adjustment in the future, the company is not responsible for notifying the reader or updating the content.

ABOUT



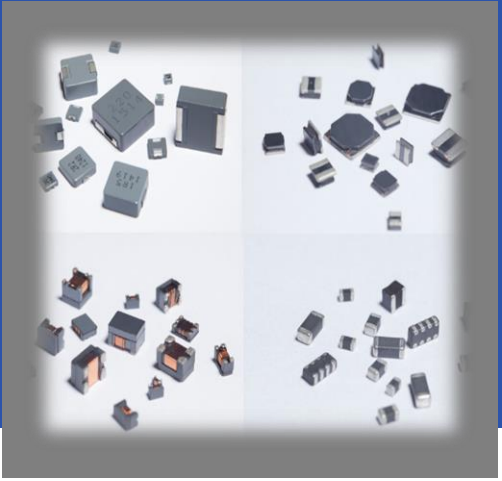
1975

Founded in 1975, until now, we have 50 years manufacturing experience



2300

4 facilities, including Taiwan, KunShan, SiHong, and Malaysia
TW-500, CN-1750
Malaysia-50



212

2025 Sales Revenue
USD 211.9 millions



29.7

2025 Selling Quantity
29.67 Billion pcs

Timeline




1975

NW E Established
Main Product: Ni-Zn Ferrite Core and material



1992

TTA merged NW E
TAI-TECH merged NW E as TAI-TECH Advanced Electronics

2000




2001

TAIPAQ Established
Main Product: Molding Power Inductor

2008



2021

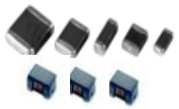
Malaysia Factory Established

2025

TAI-TECH Established
Main Product: Multilayer Chip Bead/ Inductor




TT KunShan Established
Main Product: Multilayer Chip Bead/ Inductor, Common Mode Filter

Listed Company @OTC



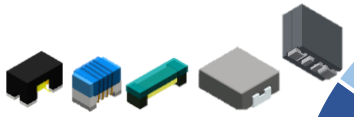
Manufacturing Facilities

Tao-Yuan, Taiwan
(Headquarter-TTA)



Est.: Oct, 1975
Employee: 500
ISO 9001
ISO 14001
ISO 14067
ISO 45001
IATF 16949

Product：
Common Mode Filter/
LAN Transformer
Wirewound Inductor
Power Inductor
Ferrite Core / Powder

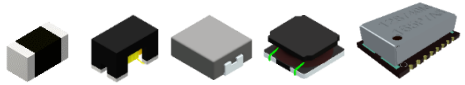


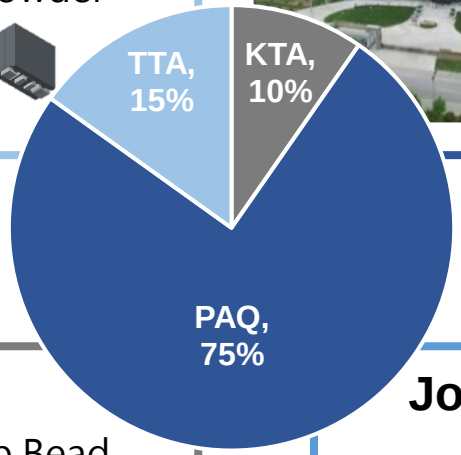
Si-Hong, Jiang-Su
(China-PAQ)



Est.: Nov, 2008
Employee: 1600
ISO 9001
ISO 14001
ISO 45001
IATF 16949

Product：
Multilayer Chip Bead
Common Mode Filter
Power Inductor
LAN Transformer Module



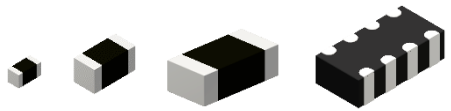


Kun-Shan, Jiang-Su
(China-KTA)



Est.: Feb, 2001
Employee: 150
ISO 9001
ISO 14001
ISO 45001
IATF 16949

Product：
Multilayer Chip Bead
Multilayer Chip Inductor

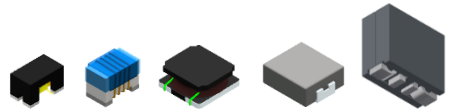


Johor, Malaysia



MP in 2025
Employee: 50
ISO 9001
ISO 14001(26Q2)

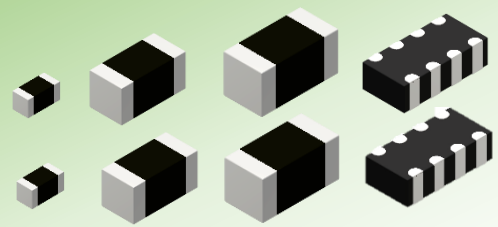
Product：
Common Mode Filter
Power Inductor
LAN Transformer



Main Products & Sales Ratio



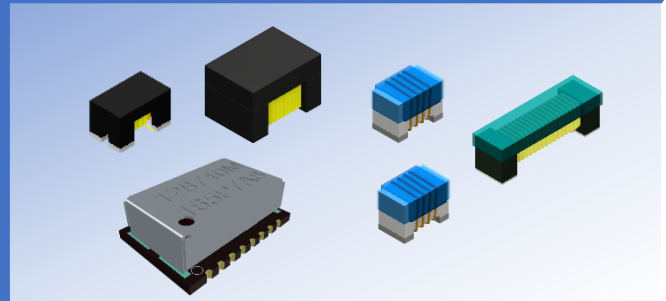
Multilayer Chip Bead / Inductor



Beads: FCB/FCM/HCB/HFZ
Size(mm): 1005 ~ 4532
Competitors:
Murata(JP), TDK(JP), YAGEO/Chilisin(TW)

Inductors: FCI/FCH/HCI/CPI
Size(mm): 1005 ~ 3216
Competitors:
Murata(JP), TY(JP), YAGEO/Chilisin(TW)

Common Mode Filter / LAN Trans Signal Inductor

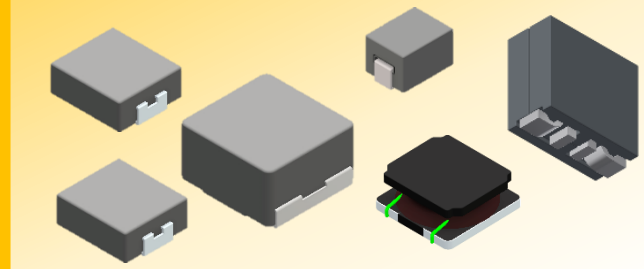


CMC：WCM/HDMI/HSF/ACM/BCM
Size(mm): 1210 ~ 9152
Competitors:
Murata(JP), TDK(JP)

LAN: TXF/DCM, LAN
Size(mm): 3216~4532

Signal: SWI/SWF/PAS/APO
Size(mm): 1608 ~ 1225
Competitors:
Murata(JP), CoilCraft(US), TDK(JP)

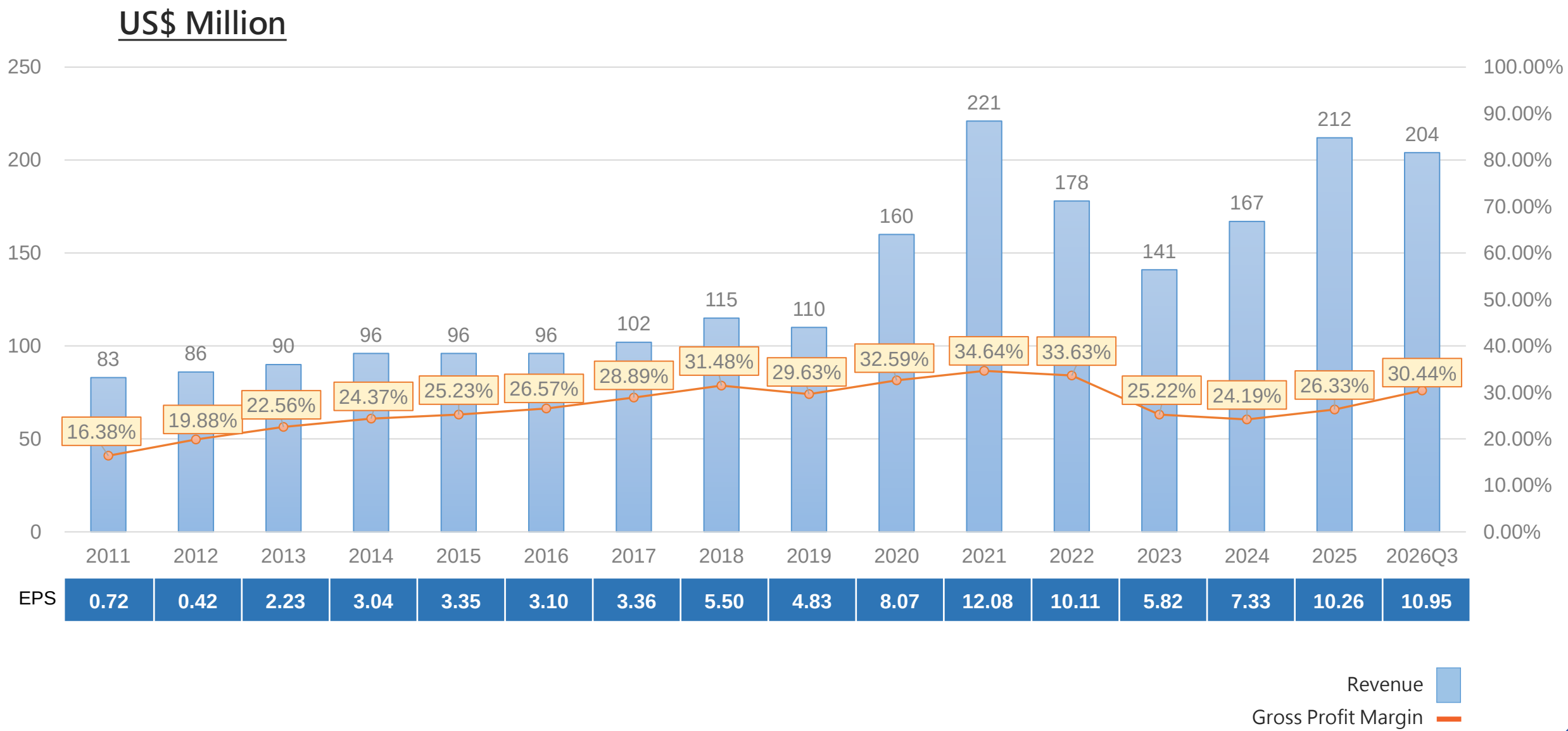
Power Inductor



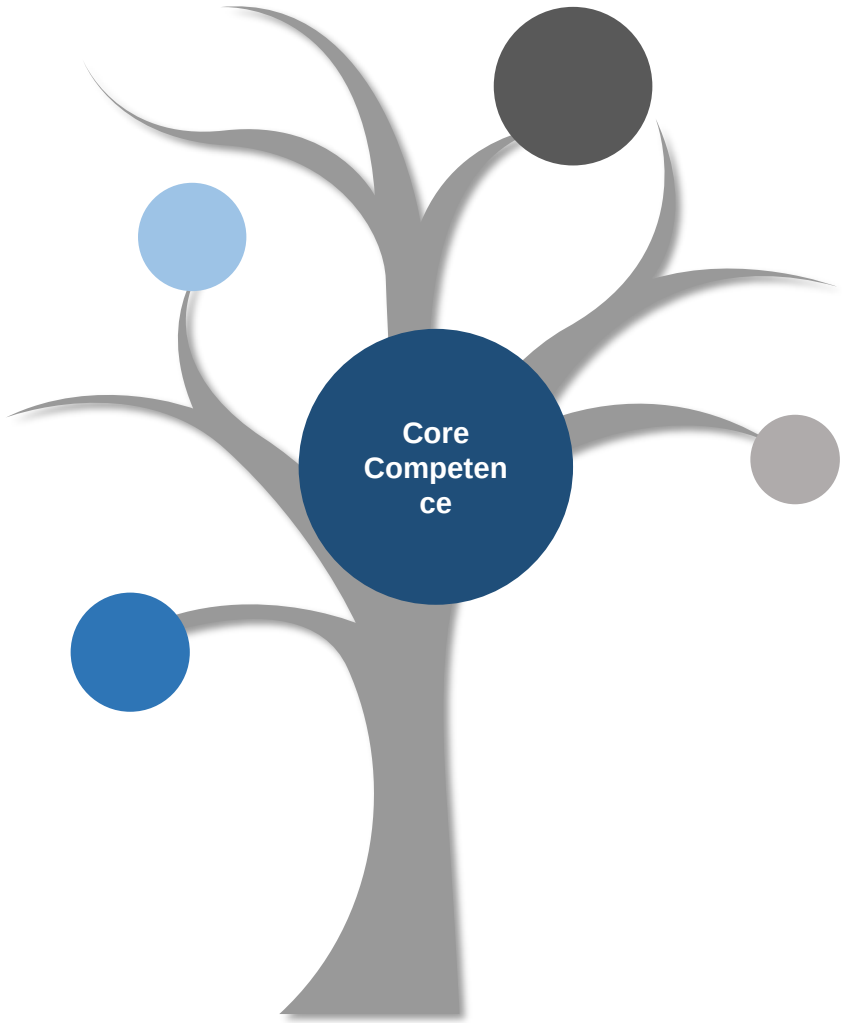
Molding: TMPC/TMPA/TMPF/TMPV/ TBMA/AWP/TMIM
Size(mm): 2.0x1.6 ~ 23x23
Competitors:
VISHAY(US), DELTA/Cyntec(TW), Coilcraft(US), Murata(JP)

Power: HPC/DFP/AHP/ SL/SEPI / TLVR
Size(mm): 1608 ~ 8x8, 4x4~11x5
Competitors:
TY(JP), EATON(US),TDK(JP),

Sales Revenue



Core Competence



Vertical Integration

Vertical integration manufacturing process from ferrite recipe to multilayer, wirewound, and molding process to assure the steady quality and cost.

Design Capabilities

Developing from ferrite core design to assure new products with excellent performance and easy to overcome any mass production issues.

Flexibilities

Multiple process such as multilayer, wirewound, molding, assembly can be applied on the required custom products to find out the best process and solutions.

Material Technology

Ferrite, alloy, ceramic materials with over 40 recipes can be chosen to achieve best electrical performance.

2026Q3 Consolidated Income Sheet

Unit：NT$ in k

	2026, Q3	2026, Q2	2025, Q3	QoQ	YoY
Operating Revenue	2,546,346	2,178,013	1,647,584	16.9%	54.6%
Gross Profit	795,302	670,122	435,991	18.7%	82.4%
(%)	31.2%	30.8%	26.5%	(+0.5ppt)	(+4.8ppt)
Operating Expenses	326,402	294,727	235,811	10.7%	38.4%
(%)	12.8%	13.5%	14.3%	(-0.7ppt)	(-1.5ppt)
Net Operating Income	468,900	375,395	200,180	24.9%	134.2%
(%)	18.4%	17.2%	12.1%	(+1.2ppt)	(+6.3ppt)
Non-operating Income & Expenses	140,221	155,611	82,100	-9.9%	70.8%
Profit of the year (Tax Paid)	535,970	437,386	253,768	22.5%	111.2%
(%)	21.0%	20.1%	15.4%	(+1.0ppt)	(+5.6ppt)
Net Income	542,936	441,009	257,969	23.1%	110.5%
EPS	4.59	3.81	2.53		

Remark 1: The quarter financial statement are the figures after audit by accountants
Remark 2: Express in thousands of New Taiwan dollars, except EPS in New Taiwan dollars

2026 9M Consolidated Income Sheet

Unit：NT$ in k

	2026 9M	2025 9M	YOY
Operating Revenue	6,459,848	4,817,530	34.1%
Gross Profit	1,965,476	1,230,519	59.7%
(%)	30.4%	25.5%	(+4.9ppt)
Operating Expenses	862,269	693,161	24.4%
(%)	13.3%	14.4%	(-1.0ppt)
Net Operating Income	1,103,207	537,358	105.3%
(%)	17.1%	11.2%	(+5.9ppt)
Non-operating Income & Expenses	357,807	338,652	5.7%
Profit of the year (Tax Paid)	1,254,521	792,372	58.3%
(%)	19.4%	16.4%	(+3.0ppt)
Net Income	1,270,192	800,232	58.7%
EPS	10.95	7.84	

Remark 1: The financial statement are the figures after audit by accountants
Remark 2: Express in thousands of New Taiwan dollars, except EPS in New Taiwan dollars

2026Q3 Consolidated Balance Sheet

Consolidated Balance Sheet and Important Financial Indicator

Unit: NT$ in k

Accounting Title	Sept. 30, 2026 Amount	%	Sept. 30, 2025 Amount	%
Cash and cash equivalents	2,097,591	13	1,717,094	13
Accounts receivable	3,651,804	22	2,433,348	19
Inventory	1,472,529	9	1,074,619	8
Long-term investment	4,460,393	27	3,233,917	25
Property, plant and equipment	3,898,149	24	4,103,580	32
Total Assets	16,536,847	100	12,937,323	100
Current Liabilities	2,833,214	17	2,672,308	21
Non-current portion of non-current borrowings	850,906	5	2,284,009	18
Total Liabilities	4,029,255	24	5,220,619	40
Total Equity	12,507,592	76	7,716,704	60
Important Financial Indicator				
Return on equity(%)	15.3		13.8	
Return on assets(%)	11.1		8.7	
EPS(NTD)	10.95		7.84	

2026Q3 Consolidated Statement of Cash Flow

Unit: NT$ in k

Cash Flow	Sept. 30, 2026	Sept. 30, 2025
	Amount	Amount
Opening Cash	2,257,597	1,780,997
Cash inflow from operating activities	447,087	563,851
Capital expenditures	(509,340)	(451,022)
Cash Dividend	(591,799)	(510,174)
Short-term borrowings	(280,000)	350,000
Long-term borrowings	(109,371)	34,889
Cash Capital Increase	0	0
Investment and others	883,417	(51,447)
Closing Cash	2,097,591	1,717,094
Free cash flow	(62,253)	112,829

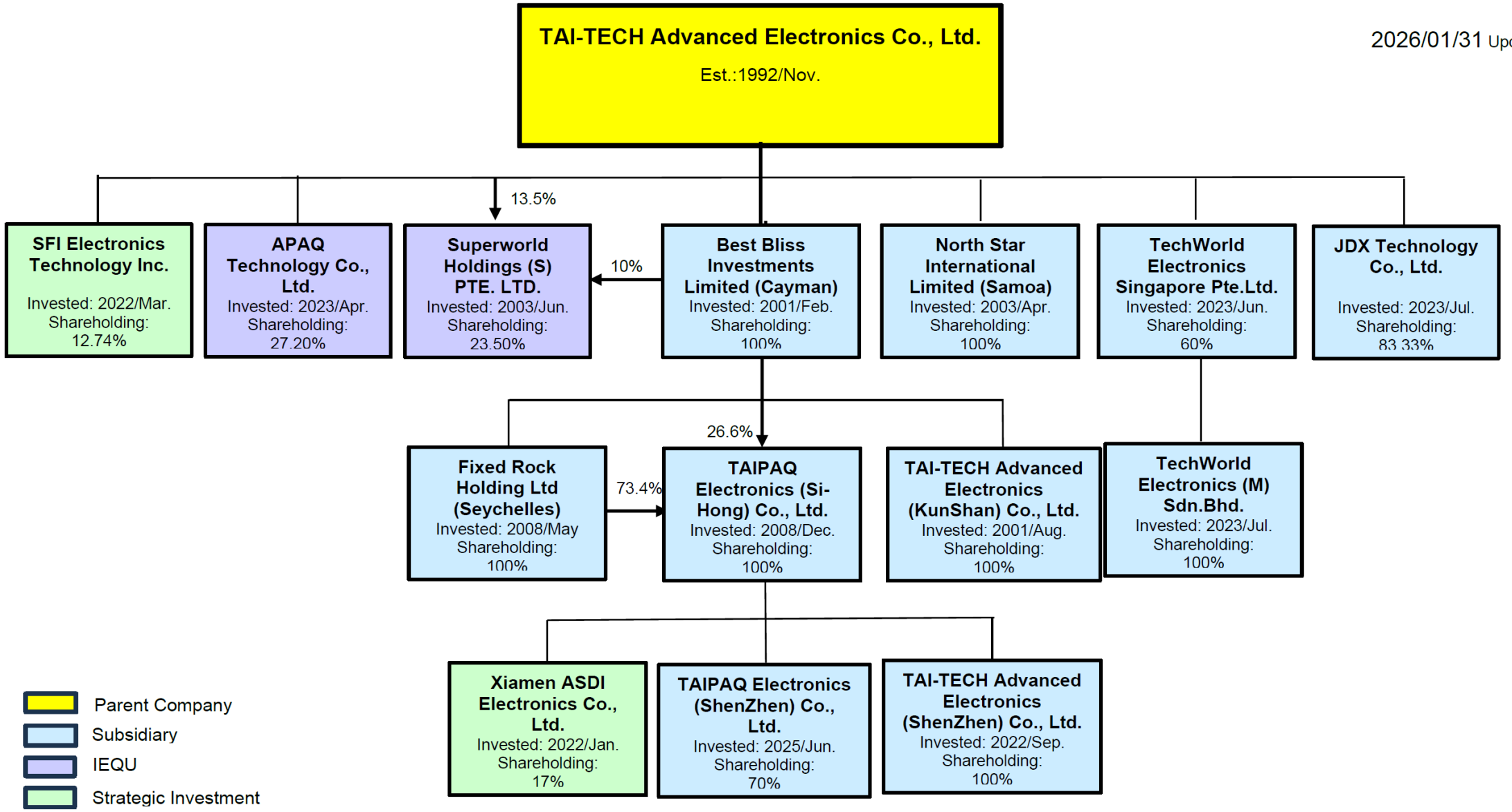
Remark: Free cash flow = Cash inflow from operating activities – Capital expenditures

2025 Dividend Policy

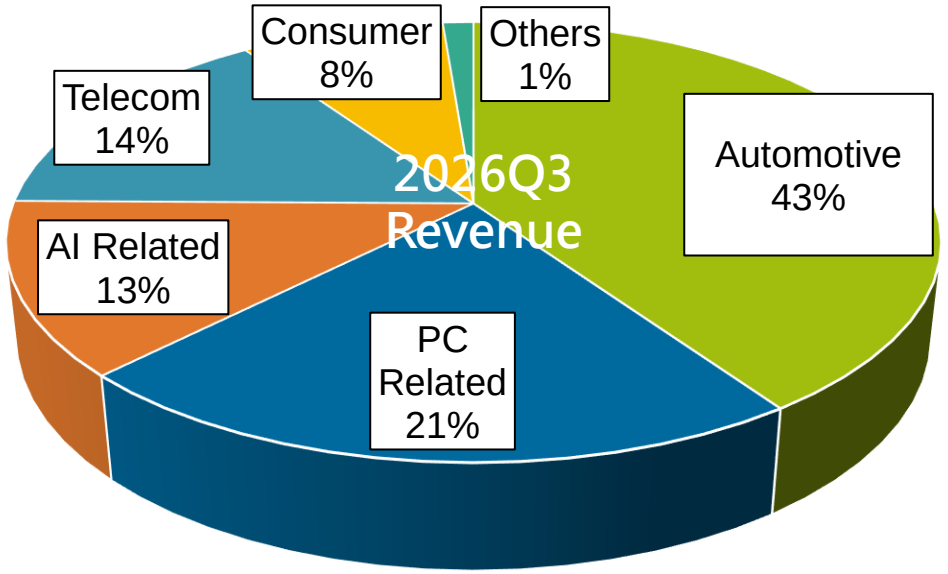
Unit: NT$ in k

Dividend Distribution	2025 Amount	2024 Amount	2023 Amount
Operating income	6,623,818	5,506,106	4,431,789
Operating Margin	793,871	566,327	463,144
Net Profit before Tax	1,224,478	851,344	669,225
Net Profit for the period	1,055,748	748,155	593,383
EPS	10.26	7.33	5.82
Dividend per share	5.2	5.0	4.5
Cash dividend	591,799	510,174	459,153
Payout ratio	56.1%	68.2%	77.4%
Capital expenditures	623,199	776,730	260,973
Depreciation and amortization	519,895	548,724	517,299
R&D Costs	216,653	202,633	155,250

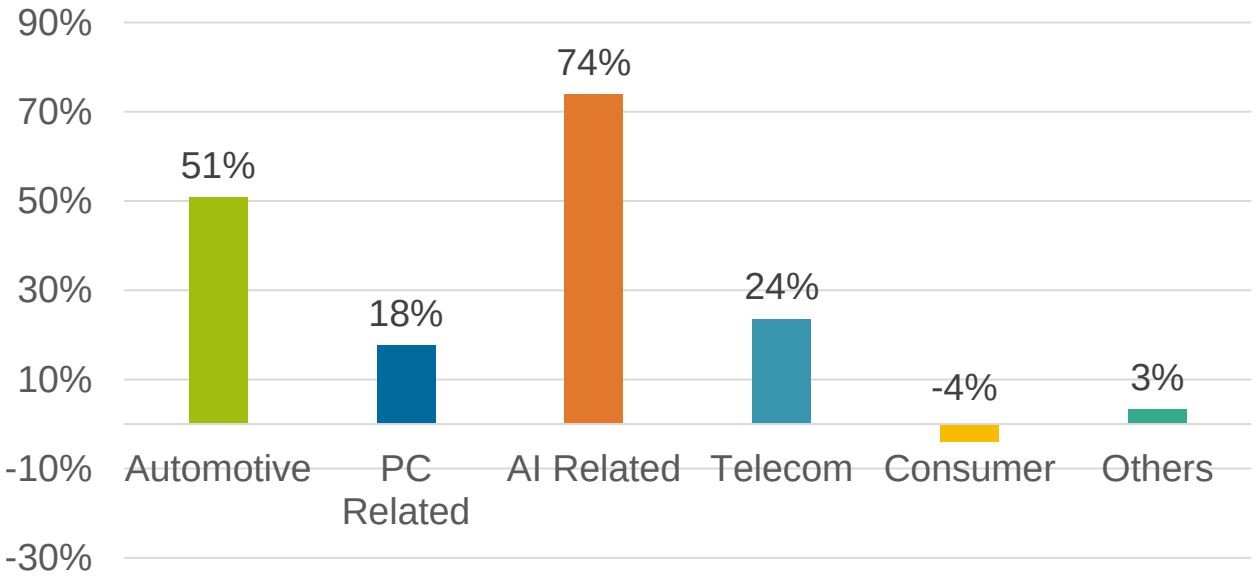
Investment Business

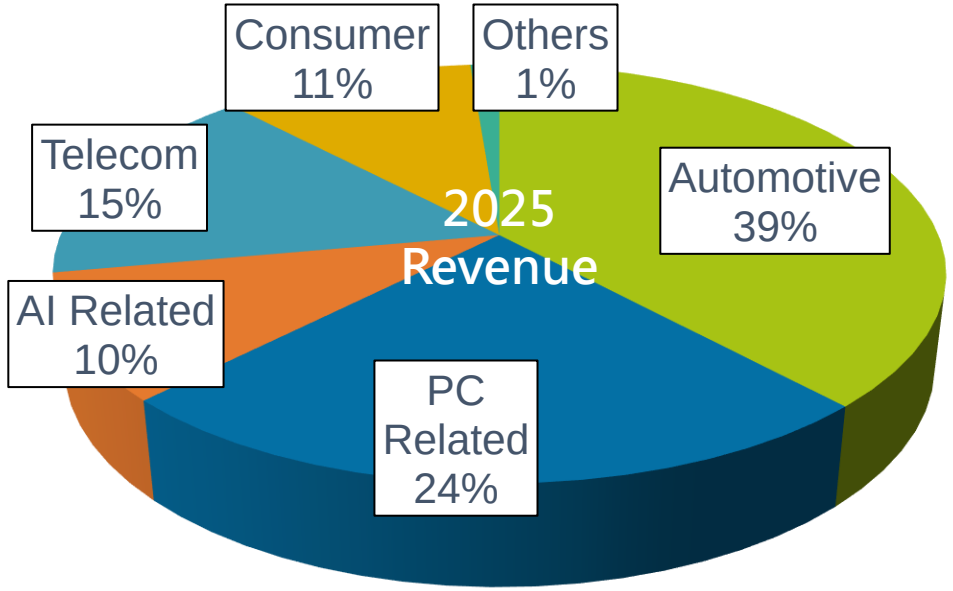


Main Customers

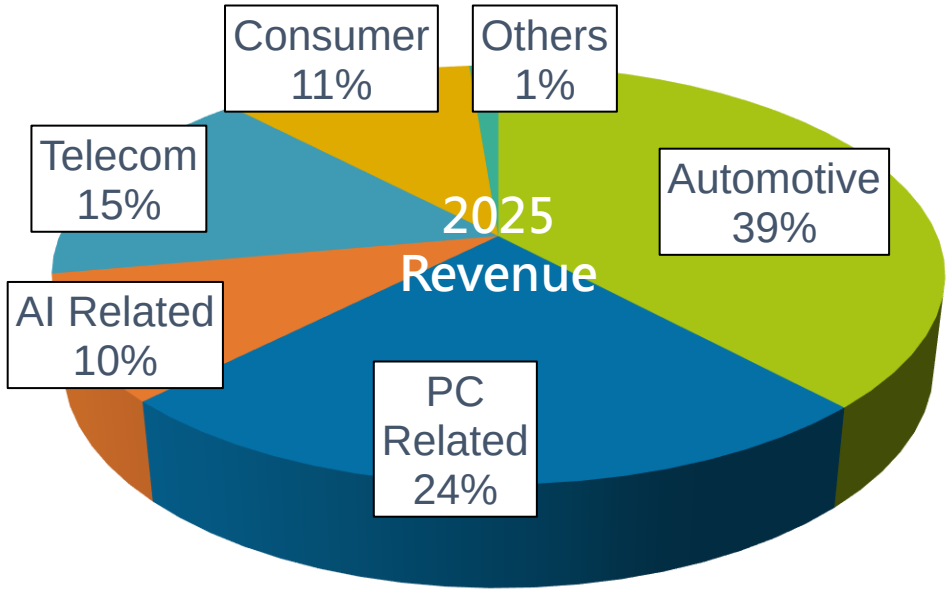


YoY (2026Q1 vs 2025Q1)

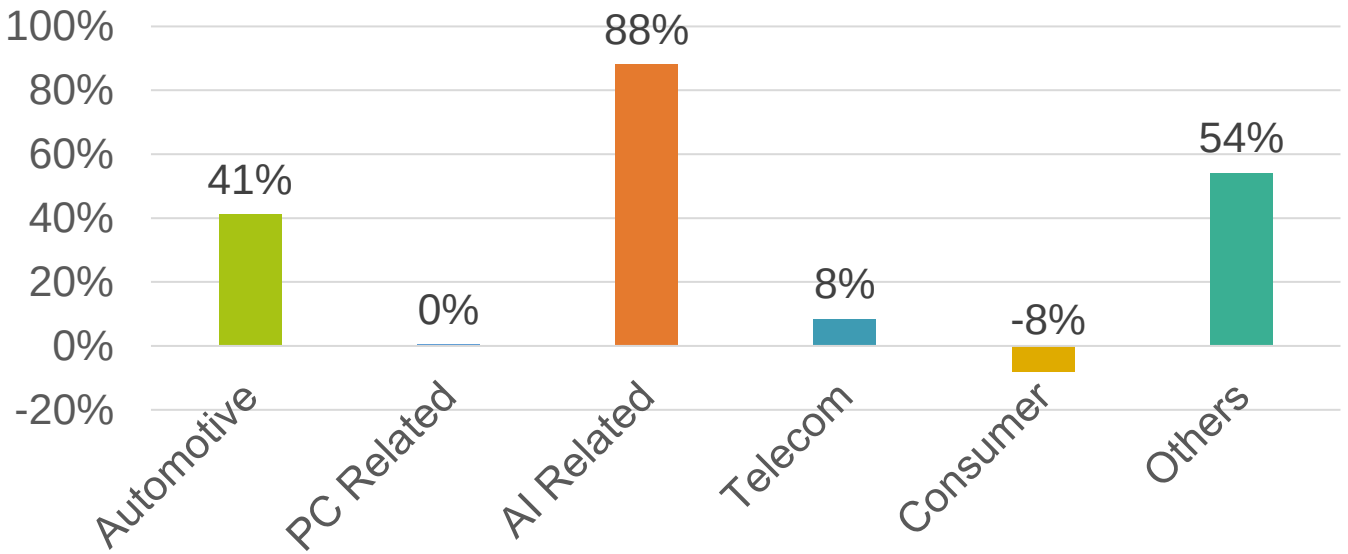


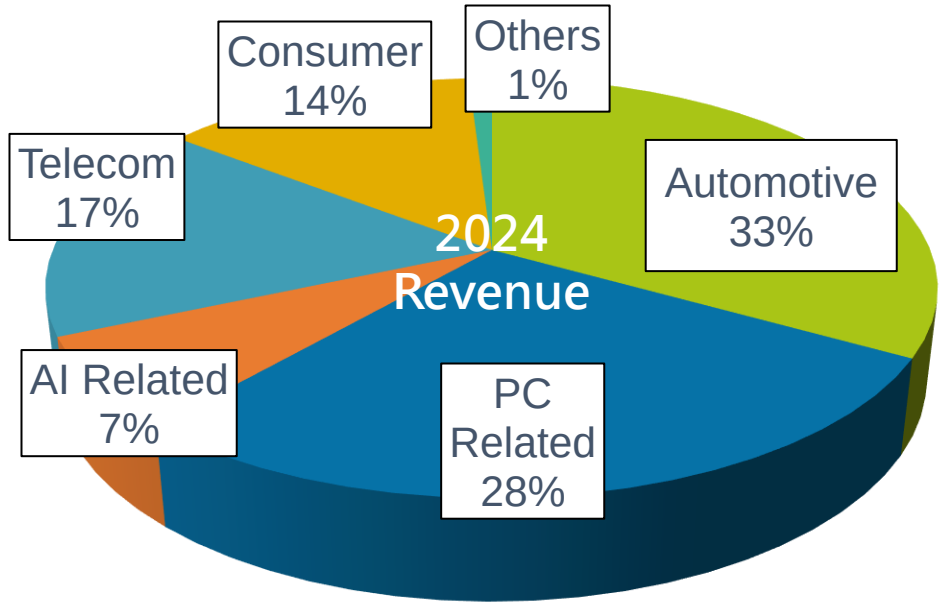


Main Customers

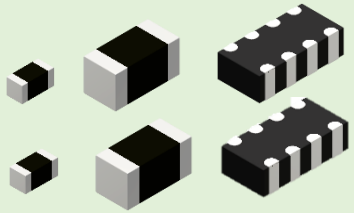
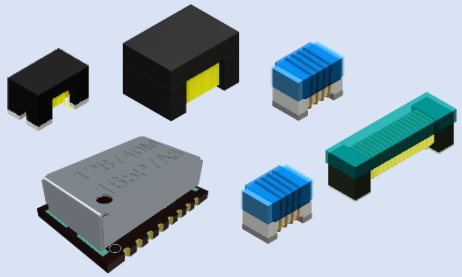
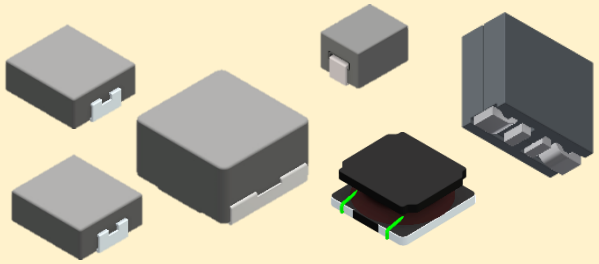


YoY (2025 vs 2024)

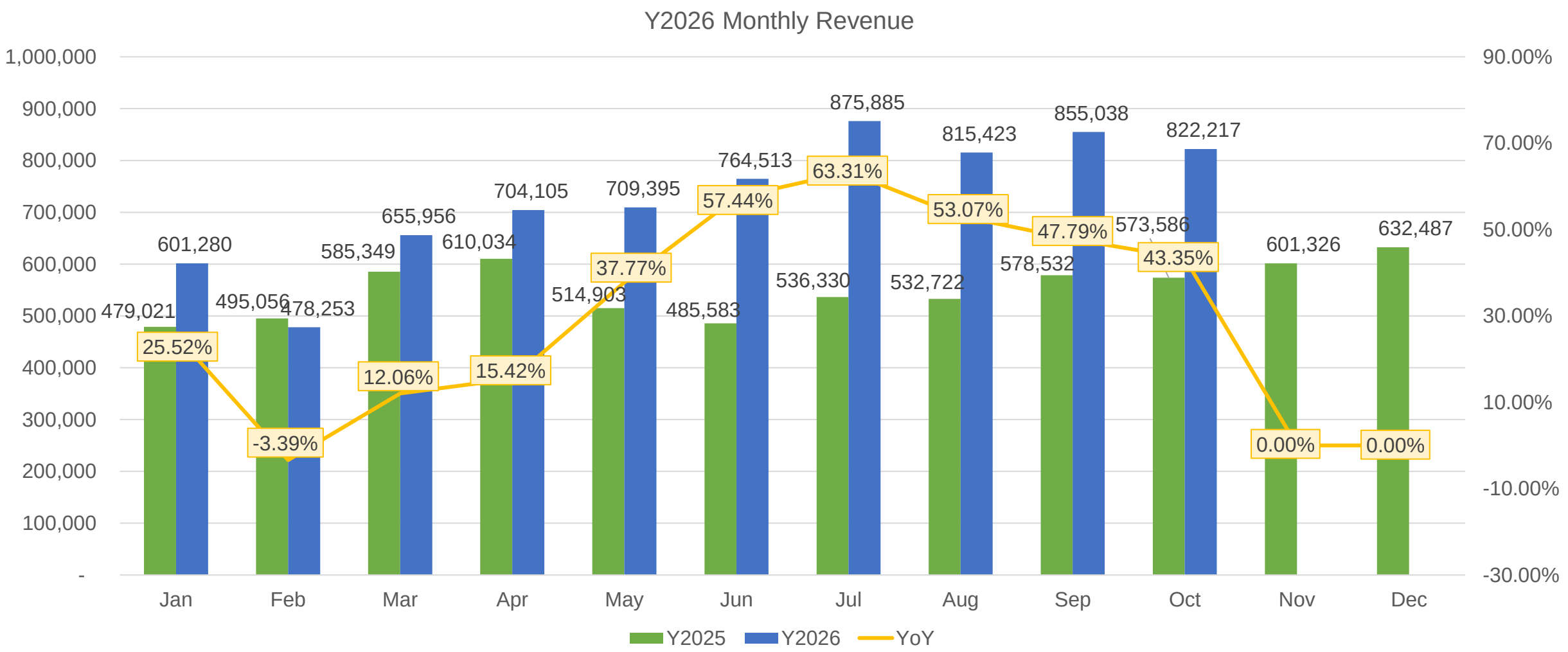




Products Sales Ratio & Profit Margin (2026)

Product Line	2026Q3 Revenue	2026Q3 Profit	2025 Revenue	2025 Profit
Multilayer Chip Bead Multilayer Chip Inductor 	20.6%	29.9%	18.3%	26.3%
Common Mode Filter LAN Transformer Signal Inductor 	17.4%		19.6%	
Power Inductor 	62.0%		62.1%	

2026 Monthly Revenue



Unit：NT$ in k

2025 Revenue	2025(Jan.-Oct.) Revenue	2026 (Jan.-Oct.) Revenue	YoY
6,624,929	5,391,116	7,282,065	+ 35.08%

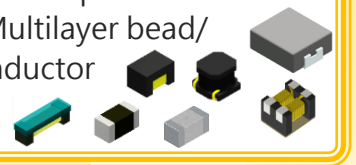
Future Focused Market & What's Next

Automotive

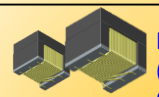


ADAS
(Camera, Radar)
IVI
(Cluster, Infotainment)
Body Sys,
(BCM, LED Lighting)
EV/HV
(EV/HV, BMS)
Comfort
(EPS, Start-stop)

- ✓ Common mode filter
- ✓ TPMS Low-freq. antenna
- ✓ Molding power inductor
- ✓ Sealed power inductor
- ✓ Multilayer bead/ inductor



Power Over Coaxial (POC)



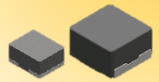
Multiple Spec Ready to be chosen (Direct cross to TDK, Murata, CoilCraft)

Automotive CMC



- Car Ethernet
- Automotive Domain Control

High Efficiency



Hot press molding achieve miniature, energy saving

Telecom

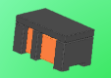


Switch HUB
AP Router
HUB
5G Base Station
IoT

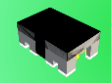
- ✓ Common mode filter
- ✓ Molding power inductor
- ✓ Sealed power inductor
- ✓ Multilayer bead/ IND.
- ✓ Wirewound IND.
- ✓ LAN Transformer



Discrete LAN Transformer



Combo Discrete Chip LAN



Discrete Chip LAN Array (2in1)

LAN Transformer Module



Function add LAN Module

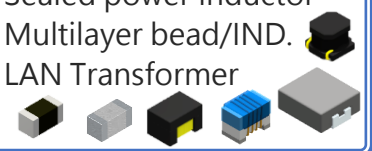
HPC



High Performance Computing

Cloud Computing
AI Server
New Gen. Memory
(DDR5)

- ✓ Common mode filter
- ✓ Molding power inductor
- ✓ Sealed power inductor
- ✓ Multilayer bead/IND.
- ✓ LAN Transformer

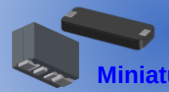


DDR5 Memory



High eff. Power IND. For next Gen.

TLVR Application

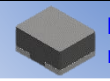


Miniature



Combo

High Efficiency



Hot press molding achieve miniature, energy saving

Corporate Sustainability

Environmental

TAI-TECH actively implements environmental responsibilities, regularly publishes corporate sustainability reports, and records environmental performance. Develop a carbon footprint verification plan to assess and monitor carbon footprints. Efforts are made to take various measures to reduce energy consumption, reduce carbon emissions, improve energy efficiency, implement energy-saving actions, and adopt renewable energy to reduce environmental impact and pursue sustainable development of the environment.



Social

The social strategies of TAI-TECH are "like-minded, symbiotic, co-prosperous, and local." For a long time, in addition to cultivating local community activities, we have also become cooperative partners with all parties. While fully safeguarding and respecting labor rights and interests, we also actively evaluate and invest in various public welfare activities to support local economic and social development. Realize the long-term goal of common prosperity and implement the spirit of sustainability.

Govenance

TAI-TECH adheres to the core value of "mutual respect, unity, and creation of development". Adhere to compliance with laws and regulations, attach importance to the rights and interests of shareholders, and respect the rights of stakeholders. An excellent corporate governance structure has been established to ensure a visible decision-making mechanism and strict responsibility system. Efficient team leaders ensure that the company' s strategy is consistent with ESG goals, continue to promote innovation, and maintain employee well-being and social contributions. Our long-term success is the result of this culture of positive corporate governance.

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THANK YOU

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